



Product Summary (@TA = +25°C)

V _{RRM} (V)	I _O (A)	V _F (V)	I _R (μA)	
1000	4	1.3	5	

Features and Benefits

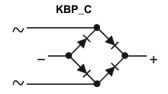
- Glass Passivated Die Construction
- · Filter Rectifier with EMI Design Friendly
- Rated at 1000V PRV
- Low Reverse Leakage Current
- Surge Overload Rating to 100A Peak
- Ideal for Printed Circuit Board Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

Suitable for AC to DC bridge full wave rectification for AC-DC power supply, LED lighting, home appliances, office equipment, and telecommunication applications.

Mechanical Data

- Case: KBP C
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Terminals: Finish Tin. Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Marked on Body
- Weight: 1.265 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

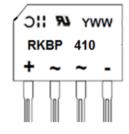
Part Number	Compliance	Case	Packaging
RKBP410	Commercial	KBP_C	35 Pieces per Tube

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- <1000ppm antimony compounds.

 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



RKBP410 = Product Type Marking Code

Oii = Manufacturer's Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 1 = 2021)

WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vrm	1000	V
Average Rectified Output Current @T _C = +105°C	lo	4	Α
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	100	Α
1^2 t Rating for Fusing (3ms \leq t \leq 8.3ms)	l ² t	41.5	A ² s

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Case (Note 5)	Rejc	5	°C/W
Typical Thermal Resistance, Junction to Lead (Note 5)	Rejl	7	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	1,000	1		>	I _R = 5μA
Forward Voltage Drop per Element (Note 7)	VF	ı	— 1.0	1.3 —	٧	IF = 4A, T _J = +25°C IF = 4A, T _J = +125°C
Leakage Current (Note 6)	I _R		— 61	5 200	μΑ	V _R = 1000V, T _J = +25°C V _R = 1000V, T _J = +125°C
Reverse Recovery Time	t _{RR}			250	ns	IF = 0.5A, I _{RR} = 0.25A, I _R = 1.0A
Total Capacitance per Element	Ст	_	40	_	pF	$V_R = 4V_{DC}, f = 1MHz$

Notes:

- 5. Thermal resistance per element. The unit mounted on fin-type heatsink (40mm x 23mm x 15.9mm).
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. 300µs pulse width, 2% duty cycle.



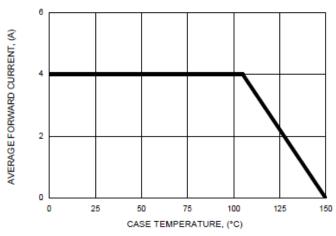


FIG.1-FORWARD CURRENT DERATING CURVE

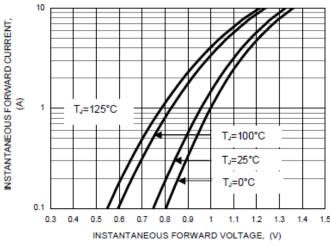


FIG.3-TYPICAL FORWARD CHARACTERISTICS

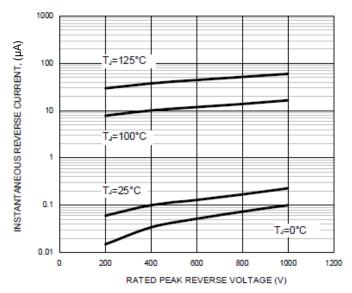


FIG.5-TYPICAL REVERSE CHARACTERISTICS

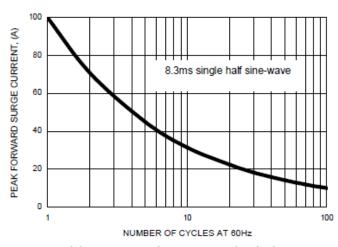


FIG.2-MAXIMUM NON-REPETITIVE SURGE CURRENT

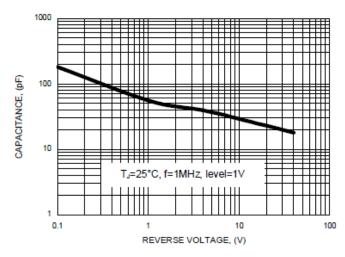


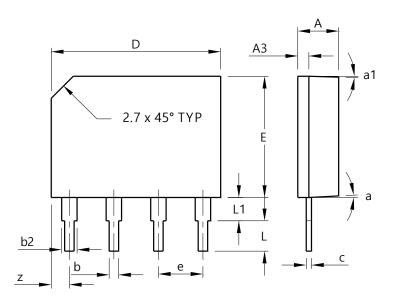
FIG.4-TYPICAL JUNCTION CAPACITANCE



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

KBP_C



KBP_C					
Dim	Min	Max	Тур		
Α	3.35	3.65	-		
A3	0.80	1.10	-		
b	0.76	0.86	-		
b2	1.22	1.42	-		
С	0.35	0.55	-		
D	14.25	14.75	-		
Е	10.20	10.60	-		
е	3.56	4.06	-		
L	2.40	2.80	-		
L1	1.80	2.20	-		
Z	1.40	1.70	-		
а	-	-	3°		
a1	-	- 2°			
All Dimensions in mm unless					
otherwise specified					



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